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SEMICONDUCTOR®

FDMS86252 N-Channel PowerTrench[®] MOSFET 150 V, 16 A, 51 m Ω

Features

- Max $r_{DS(on)} = 51 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A}$
- Max $r_{DS(on)}$ = 70 m Ω at V_{GS} = 6 V, I_D = 3.9 A
- Advanced package and silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

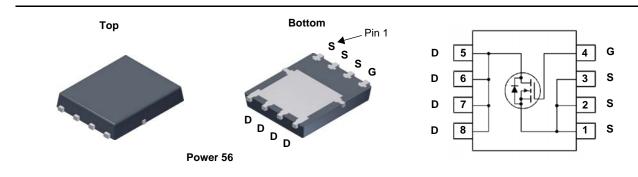


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			150	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		16		
	-Continuous (Silicon limited) T _C = 25 °C			24	_	
	-Continuous	T _A = 25 °C	(Note 1a)	4.6	Α	
	-Pulsed			20		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	50	mJ	
	Power Dissipation	T _C = 25 °C		69		
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature R	ange		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.8	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a	l) 50	C/VV

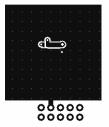
Package Marking and Ordering Information

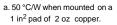
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86252	FDMS86252	Power 56	13 "	12 mm	3000 units

⁻ DMS86252
N-Channel
PowerTrench [®]
MOSFET

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		106		mV/°0
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Chara	octeristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.0	2.8	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-9		mV/°0
		V _{GS} = 10 V, I _D = 4.6 A		43.9	51	
(DO())	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 3.9 A$		50.5	70	mΩ
r _{DS(on)}		$V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A},$ $T_J = 125 \text{ °C}$		83	96	11152
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 4.6 A		15		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 75 V, V_{GS} = 0 V,$ f = 1 MHz		678 74 4.3	905 115 10	pF pF pF
R _g	Gate Resistance			0.4		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			7.7	16	ns
t _r	Rise Time	V _{DD} = 75 V, I _D = 4.6 A,		2.3	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		15	27	ns
t _f	Fall Time			3.2	10	ns
Q _g	Total Gate Charge	$V_{GS} = 0$ V to 10 V		11	15	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 75 V,$		6.1	8.6	nC
Q _{gs}	Gate to Source Charge	I _D = 4.6 A		2.8		nC
Q _{gd}	Gate to Drain "Miller" Charge			2.4		nC
Drain-Sou	urce Diode Characteristics					
V _{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.75	1.2	v
		$V_{GS} = 0 V, I_S = 4.6 A$ (Note 2)		0.80	1.3	
t _{rr}	Reverse Recovery Time	— I _F = 4.6 A, di/dt = 100 A/μs		56	90	ns
Q _{rr}	Reverse Recovery Charge			61	98	nC



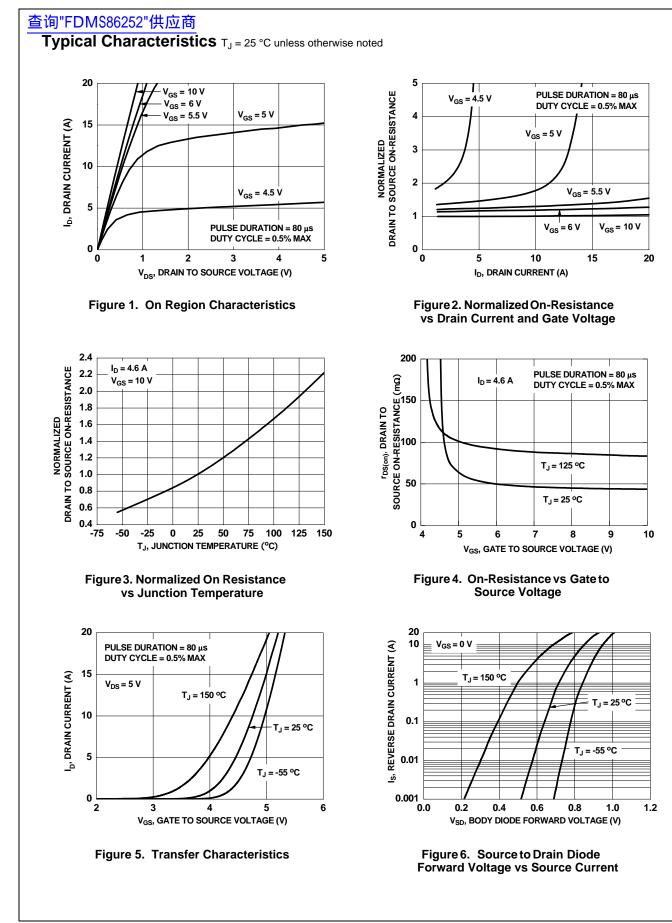


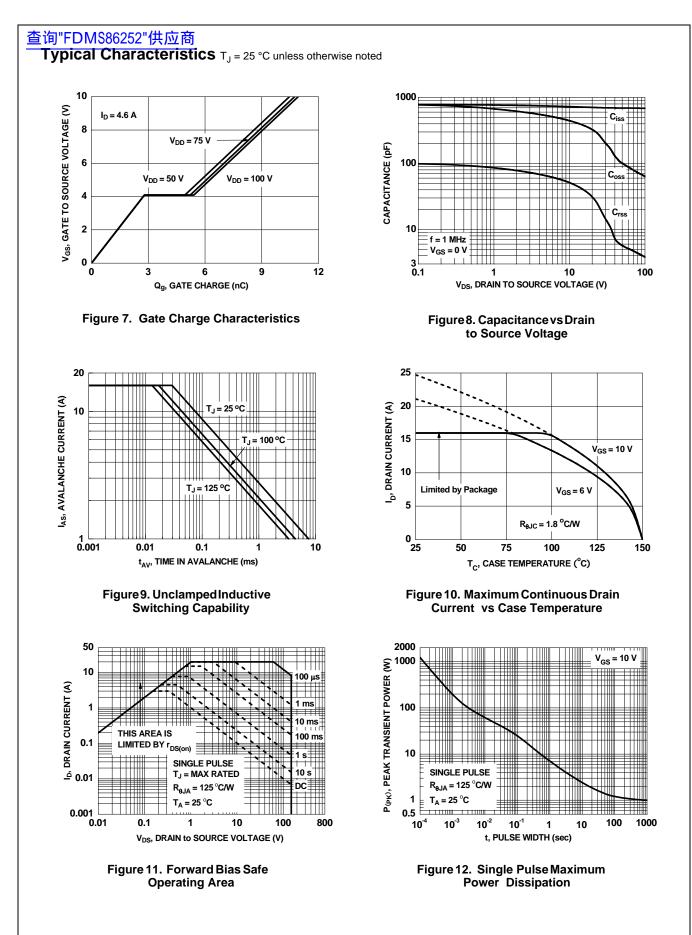
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

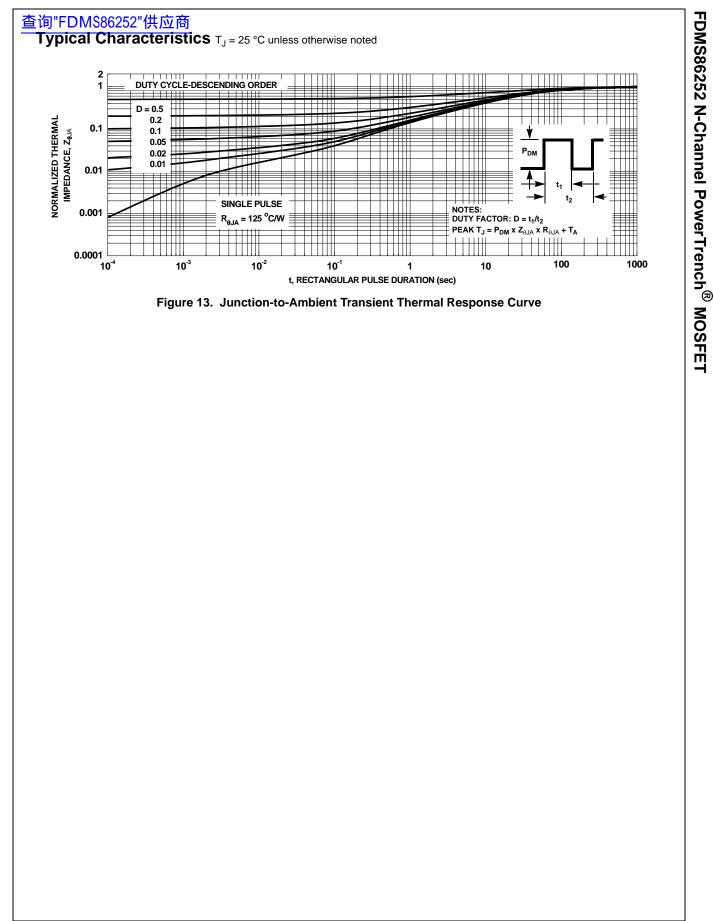


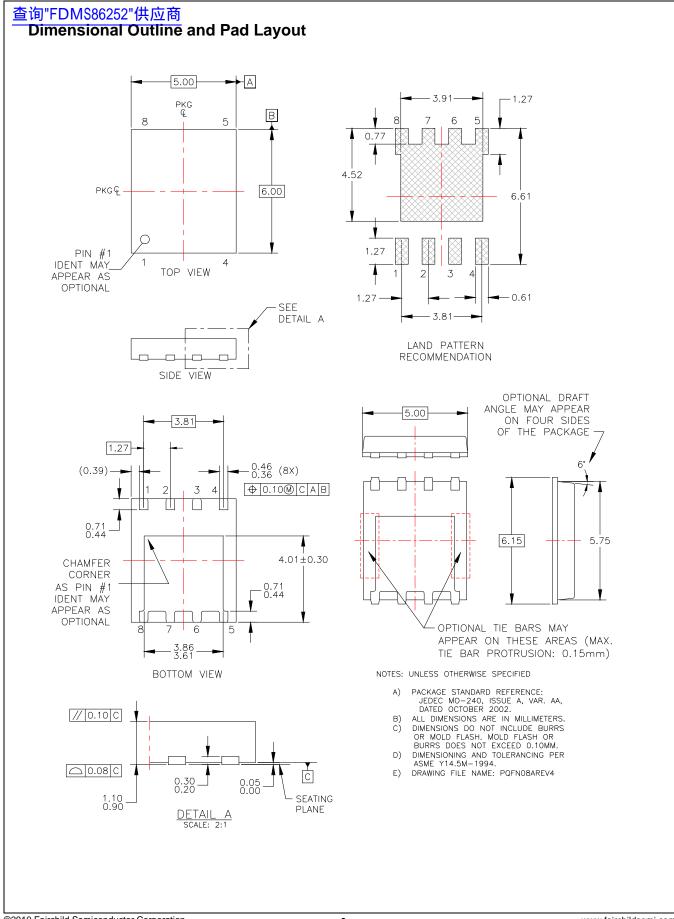
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25 $^{o}C,\,L$ = 1 mH, I_{AS} = 10 A, V_{DD} = 135 V, V_{GS} = 10 V.









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